

**In the Claims**

1. (Previously Presented) Blister package arrangement with a blister package and a conductor carrier connected to it, wherein openings in the conductor carrier are directed toward pockets of the blister package, and wherein, upon removal of a tablet from a pocket, a sealing film of the blister package sealing the pocket must be separated, and the tablet is removable through an opening assigned to it, the improvement wherein the openings are formed by stamped lines positioned within the conductor carrier that surround each of the pockets in a ring shape, and that are interrupted by at least two bridge parts by means of which a covering, separated by the stamped line out of the conductor carrier and covering the pocket, is connected with the conductor carrier ; wherein the bridge parts are so distributed about the periphery of the stamped line that, when a tablet is pressed out from a pocket, at least one bridge part is broken; and wherein the conductor carrier includes individual conductors each of which extends from an individual connecting pad over at least the one bridge part that is severed upon tablet removal.

2. (Previously Presented) Blister package arrangement as in Claim 1, wherein each individual conductor, at its end opposite its associated individual connection pad, is connected with a common conductor which is connected to a common connection pad.

3. (Previously Presented) Blister package arrangement as in Claim 2, wherein the individual connecting pads and the common connection pad are components of an interface, which upon insertion of the blister package arrangement in a receiver device, effect a defined position orientation and is electrically connected with an electronic unit in the receiver device to detect the severance of the individual conductors.

4. (Previously Presented) Blister package arrangement as in Claim 1, wherein the stamped lines have a shape selected from the group consisting of rectangular, circular, and oval.

5. (Previously Presented) Blister package arrangement as in Claim 1, wherein the bridge parts are positioned diametrically opposite each other about the circumference of the stamped line, and wherein the individual conductor associated therewith extends over both bridge parts.

6. (Previously Presented) Blister package arrangement as in Claim 5, wherein the two bridge parts each lie along the direction of the longer extension of the stamped line.

7. (Previously Presented) Blister package arrangement as in Claim 6, wherein the individual conductor extends over the first and the additional bridge parts.

8. (Previously Presented) Blister package arrangement as in Claim 1, wherein the individual conductor extends only over one of the bridge parts from the conductor carrier to the covering, and from the covering back to the conductor carrier as a loop, whereby the conductor-bearing bridge part is positively severed upon tablet removal.

9. (Previously Presented) Blister package arrangement as in Claim 1, wherein the conductor carrier includes the individual conductors on the side facing away from the blister package, and is attached to the side facing toward the blister package by means of the sealing film of the blister package.

10. (Previously Presented) Blister package arrangement as in Claim 9, wherein the conductor carrier is at least partially provided with an electrically insulating protective on its side facing away from the blister package that covers at least the individual conductors and a common conductor.

11. (Previously Presented) Blister package arrangement as in Claim 1, wherein the conductor carrier includes the individual conductors on its side facing toward the blister package, and that the side of the conductor carrier facing toward the blister package is provided with an electrically insulating layer covering the individual conductors, and wherein the side of the electrically insulating layer facing toward the blister package is connected with the sealing film of the blister package.

12. (Previously Presented) Blister package arrangement as in Claim 11, wherein the electrically insulating layer is provided with an adhesive layer that may be connected with the sealing film of the blister package.

13. (Previously Presented) Blister package arrangement as in Claim 12, wherein the adhesive layer is covered by a tear film that may be separated from the adhesive layer in order to connect the adhesive layer to the sealing film.

14. (Previously Presented) Blister package arrangement as in Claim 2, wherein the conductor carrier projects over the blister package at least on the side of the interface.

15. (Previously Presented) Blister package arrangement as in Claim 1, wherein the conductor carrier forms a first component of the carrier that folds like a book, and a second component forms at least one of an insertion opening for each pocket of the blister package and a common insertion opening for all pockets of the blister package, and may be folded about a fold line with respect to the conductor carrier so that the blister package is accepted between the conductor carrier and the second part, whereby each pocket of the blister package extends through an insertion opening of the second component or all pockets of the blister package through the common insertion opening of the second component, and wherein the conductor carrier, the blister package, and the second component receiving the pockets of the blister package are connected with each other.

16. (Previously Presented) Blister package arrangement as in Claim 15, wherein the conductor carrier and the second component project over the blister package at least on the side of an interface of the conductor carrier with a receiver device.

17. (Previously Presented) Blister package arrangement as in Claim 15, wherein the conductor carrier and the second component project over the blister package on all sides.

18. (Previously Presented) Blister package arrangement as in Claim 15, wherein the fold line extends along the longer side of the conductor carrier and the second component.

19. (Previously Presented) Blister package arrangement as in Claim 15, wherein the conductor carrier, the blister package and the second component receiving the pockets of the blister package are adhered together.

20. (Previously Presented) Blister package as in Claim 11, wherein the electrically insulating layer is simultaneously an adhesive layer that may be connected to the sealing film of the blister package.

21. (Previously Presented) A blister package arrangement comprising:  
a blister package having a plurality of pockets each configured to receive a tablet therein; and  
a conductor carrier connected to the blister package, the conductor carrier comprising:

a cover area positioned adjacent to each pocket in the blister package, each cover area defined by a stamped line opening formed thereabout in the conductor carrier;

at least two bridge parts interrupting each stamped line opening to connect each cover area to a surrounding conductor carrier area, the at least two bridge parts positioned such that at least one bridge part is broken when a tablet is pressed out from the corresponding pocket; and

an individual conductor extending over the at least one bridge part, the individual conductor configured to break along with the at least one bridge part that is broken when a tablet is pressed out from the corresponding pocket.